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INTERNATIONAL STANDARD

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Part 21: Device Onboarding
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CONTENTS

FOREWORD	4
1 Scope	6
2 Normative references	6
3 Terms, definitions and abbreviated terms	7
3.1 Terms and definitions.....	7
3.2 Abbreviated terms.....	9
4 Onboarding Model	9
4.1 Device lifecycle.....	9
4.2 Concepts	12
4.2.1 Secure elements.....	12
4.2.2 Firmware and Applications.....	12
4.2.3 Transfer of physical control.....	13
4.2.4 Trust on first use (TOFU).....	14
4.2.5 SoftwareUpdateManager	14
4.2.6 Roles and privileges	14
4.3 Device workflows	15
4.3.1 Distribution	15
4.3.2 Onboarding.....	15
4.3.3 Application setup	15
4.3.4 Configuration	16
4.3.5 Operation	16
4.3.6 Decommissioning	16
5 Identities	16
5.1 Overview	16
5.2 Device identity	17
5.3 ProductInstanceUri	IEC 62541-21:2026
5.4 Composite identity	18
6 Ticket semantics.....	19
6.1 Tickets	19
6.2 Ticket distribution	20
6.3 Authentication.....	20
6.4 Acquiring and validating tickets.....	21
7 Device Authentication.....	22
7.1 Overview	22
7.2 Pull Management.....	24
7.3 Push Management	26
7.4 Alternate authentication models	27
8 Ticket syntax	29
8.1 Signed ticket encoding.....	29
8.2 Ticket Types	30
8.2.1 EncodedTicket.....	30
8.2.2 BaseTicketType	30
8.2.3 DeviceIdentityTicketType	31
8.2.4 CompositeIdentityTicketType	32
8.2.5 TicketListType	32
8.2.6 CertificateAuthorityType	33

9	Information Model.....	34
9.1	Overview	34
9.2	Registrar.....	34
9.2.1	Overview	34
9.2.2	DeviceRegistrarType	34
9.2.3	ProvidedIdentities.....	35
9.2.4	UpdateSoftwareStatus.....	36
9.2.5	RegisterDeviceEndpoint	37
9.2.6	GetManagers.....	38
9.2.7	ManagerDescription.....	39
9.2.8	RegisterManagedApplication	40
9.2.9	DeviceRegistrar.....	41
9.2.10	DeviceRegistrarAdminType.....	41
9.2.11	RegisterTickets.....	42
9.2.12	UnregisterTickets	43
9.2.13	DeviceRegistrationAuditEventType	43
9.2.14	DeviceIdentityAcceptedAuditEventType	44
9.2.15	DeviceSoftwareUpdatedAuditEventType	45
9.3	Device Configuration Application (DCA).....	45
9.3.1	Overview	45
9.3.2	ProvisionableDevice	46
9.3.3	ProvisionableDeviceType	47
9.3.4	RequestTickets	48
9.3.5	SetRegistrarEndpoints	48
9.3.6	ApplicationConfigurationType	49
10	Namespaces.....	50
10.1	Namespace Metadata	50
10.2	Handling of OPC UA Namespaces	50
Annex A (normative) Namespaces and Identifiers https://standards.iec.ch/IEC/62541-21:2026/AnnexA.pdf		
A.1	Namespace and Identifiers for the Onboarding Information Model.....	52
A.2	Capability Identifier.....	52
Bibliography.....		
Figure 1 – The Lifecycle of a Device		10
Figure 2 – Device hardware and software layers		12
Figure 3 – Possible Transfers of physical control		13
Figure 4 – Relationship between Devices, Actors, Identifiers and Tickets		17
Figure 5 – Device Authentication using Pull Management		24
Figure 6 – Requesting Certificates using Pull Management.....		25
Figure 7 – Device Authentication using Push Management		26
Figure 8 – Updating Certificates using Push Management		27
Figure 9 – Alternate authentication models with Pull Management		28
Figure 10 – Registrar Address Space for Onboarding Workflow		34
Figure 11 – Device Address Space for Onboarding Workflows		46
Table 1 – The Actors in the Device Lifecycle.....		11

Table 2 – The Stages in the Device Lifecycle	11
Table 3 – Well-known Roles for Onboarding	15
Table 4 – Privileges for Onboarding	15
Table 5 – RFC 7515 Header Fields	30
Table 6 – EncodedTicket Definition	30
Table 7 – BaseTicketType Structure	31
Table 8 – BaseTicketType Definition	31
Table 9 – DeviceIdentityTicketType Structure	31
Table 10 – DeviceIdentityTicketType Definition	32
Table 11 – CompositeIdentityTicketType Structure	32
Table 12 – CompositeIdentityTicketType Definition	32
Table 13 – TicketListType Structure	33
Table 14 – TicketListType Definition	33
Table 15 – CertificateAuthorityType Structure	33
Table 16 – CertificateAuthorityType Definition	33
Table 17 – DeviceRegistrarType Definition	35
Table 18 – ProvideIdentities Method AddressSpace Definition	36
Table 19 – UpdateSoftwareStatus Method AddressSpace Definition	37
Table 20 – RegisterDeviceEndpoint Method AddressSpace Definition	38
Table 21 – GetManagers Method AddressSpace Definition	39
Table 22 – ManagerDescription Structure	39
Table 23 – ManagerDescription Definition	40
Table 24 – RegisterManagedApplication Method AddressSpace Definition	41
Table 25 – DeviceRegistrar Definition	41
Table 26 – DeviceRegistrarAdminType Definition	41
Table 27 – RegisterTickets Method AddressSpace Definition	42
Table 28 – UnregisterTickets Method AddressSpace Definition	43
Table 29 – DeviceRegistrationAuditEventType Definition	44
Table 30 – DeviceIdentityAcceptedAuditEventType Definition	44
Table 31 – DeviceSoftwareUpdatedAuditEventType Definition	45
Table 32 – ProvisionableDevice Object Definition	47
Table 33 – ProvisionableDeviceType Definition	47
Table 34 – RequestTickets Method AddressSpace Definition	48
Table 35 – SetRegistrarEndpoints Method AddressSpace Definition	49
Table 36 – ApplicationConfigurationType Definition	49
Table 37 – NamespaceMetadata Object for this Document	50
Table 38 – Namespaces used in this document	51

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**OPC unified architecture -
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The text of this International Standard is based on the following documents:

Draft	Report on voting
65E/1046/CDV	65E/1103/RVC

Full information on the voting for its approval can be found in the report on voting indicated in the above table.

The language used for the development of this International Standard is English.

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The *italicized terms* and *names* are also often written in camel-case (the practice of writing compound words or phrases in which the elements are joined without spaces, with each element's initial letter capitalized within the compound). For example, the defined term is *AddressSpace* instead of Address Space. This makes it easier to understand that there is a single definition for *AddressSpace*, not separate definitions for Address and Space.

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